

C1206X473J5GACTU

Aliases (C1206X473J5GAC7800) SMD Comm COG Flex, Ceramic, 0.047 uF, 5%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	25 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	0.047 uF
0.4mm	Measurement Condition	1 kHz 1.0Vrms
).35mm	Tolerance	5%
.20mm	Voltage DC	50 VDC
	Dielectric Withstanding Voltage	125 VDC
0.25mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
n, Plastic Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Pate	0% Loss /Decade Hour

Aging Rate0% Loss/Decade HourInsulation Resistance21.2766 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

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Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
т	1.1mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

Packaging Specifications Packaging

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500